

8kV 300mA HIGH VOLTAGE DIODE

ESJC30-08 is high reliability resin molded type high voltage diode in small size package which is sealed a multilayered mesa type silicon chip by epoxy resin.

Features

- High speed switching
- Low VF
- High surge resistivity for CRT discharge
- High reliability design
- Ultra small package

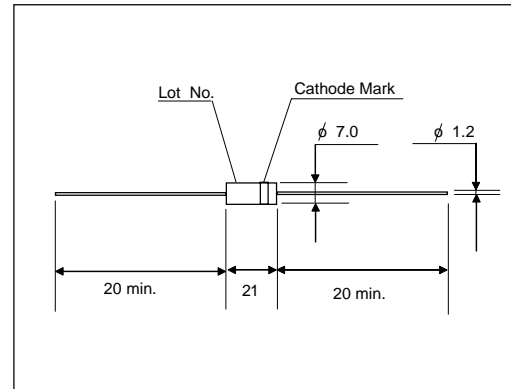
Applications

- X light Power supply
- Laser
- Voltage doubler circuit
- Microwave emission power

Maximum Ratings and Characteristics

- Absolute Maximum Ratings

Outline Drawings : mm



Cathode Mark

Type	Mark
ESJC30-08	

Items	Symbols	Condition	ESJC30-08	Units
Repetitive Peak Reverse Voltage	V_{RRM}		8.0	kV
Average Output Current	I_o	$T_a=25^{\circ}\text{C}$, Resistive Load	300	mA
Surge Current	I_{FSM}		15	A_{peak}
Junction Temperature	T_j		120	$^{\circ}\text{C}$
Allowable Operation Case Temperature	T_c		120	$^{\circ}\text{C}$
Storage Temperature	T_{stg}		-40 to +125	$^{\circ}\text{C}$

- Electrical Characteristics ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

Items	Symbols	Conditions	ESJC30-08	Units
Maximum Forward Voltage Drop	V_F	at 25°C , $I_F=I_{F(AV)}$	20	V
Maximum Reverse Current	I_{R1}	at 25°C , $V_R=V_{RRM}$	5.0	μA
	I_{R2}	at 100°C , $V_R=V_{RRM}$	50	μA
Maximum Reverse Recovery Time	T_{rr}	at 25°C	150	nS
Junction Capacitance	C_j	at 25°C , $V_R=0\text{V}$, $f=1\text{MHz}$	15	pF